

**OLIFF & BERRIDGE, PLC**

ATTORNEYS AT LAW

**Application Data Sheet**

**Applicant Information**

Applicant Authority type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Osamu
Family Name::	ITATANI
City of Residence::	Kyoto-shi
Country of Residence::	Japan

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Masato
Family Name::	SAGAWA
City of Residence::	Kyoto-shi
Country of Residence::	Japan

**Correspondence Information**

Correspondence Customer Number::	25944
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**Application Information**

Application Type::	National Phase
Subject Matter::	Utility
CD-ROM or CD-R::	None
Title::	METHOD FOR FORMING ADHESIVE LAYER
Attorney Docket Number::	125433
Suggested Drawing Figure::	3
Total Drawing Sheets::	3
Small Entity::	Yes

**Representative Information**

James A. Oliff, Reg. No. 27,075  
Thomas J. Pardini, Reg. No. 30,411  
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<b>Domestic Priority Information</b>			
Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application is a	National Stage of	PCT/JP2004/007626	06/02/2004
<b>Foreign Priority Information</b>			
Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2003-161500	06/06/2003	Yes
<b>Assignee Information</b>			
Assignee Name::		INTERMETALLICS CO., LTD.	
Street of mailing address::		22-1, Oiage-cho, Matsumuro, Nishikyo-ku,	
City of mailing address::		Kyoto-shi,	
State or Province of mailing address::		Kyoto	
Country of mailing address::		615-8206	
Postal or Zip Code of mailing address::		Japan	